

ICEP-IAAC 2012

Joint Conference of "International Conference on Electronics Packaging"
and "IMAPS All Asia Conference"

April 17-20, 2012
Tokyo Big Sight, Tokyo, Japan

Sponsored by JIEP, IEEE CPMT Society Japan Chapter and IMAPS



About the joint conference of ICEP-IAAC

The JIEP was requested to hold the IMAPS All Asia Conference (IAAC) by the IMAPS. In response, the JIEP made a proposal to hold it as the joint conference with ICEP based on the discussions in the international affairs committee of the JIEP. Since it was well accepted by Asian Members such as China, Hong Kong, Korea, Taiwan, as well as US and Europe, the JIEP decided to hold ICEP 2012 as a joint conference with the 1st IAAC.

We think it is very important and meaningful that we will have the conference on electronics packaging under cooperation of various Asian members. Currently, after the 1st joint conference, Taiwan, Korea and Japan will hold the IAAC in that order.

Organizing Committee:

General Chair: Y. Orii, IBM Japan

Vice General Chairs: S. Yamamichi, RenesasElectronics

Y. Nogami, Toray Engineering

Y. Ando, Fujikura

Contact:

Secretariat of ICEP2012

Call for Papers

Sessions and Keywords:

- | | |
|--------------------------------------|-------------------------------------|
| 1. Advanced Packaging | 10. MEMS/Sensor |
| 2. Substrate | 11. Self-organization/Self-assembly |
| 3. Design, Modeling, and Reliability | 12. Emerging Technologies |
| 4. Thermal Management | 13. RF |
| 5. Manufacturing and Process | 14. Automotive Electronics |
| 6. Interconnection | 15. Energy and Environment |
| 7. Optoelectronics | 16. Metrology |
| 8. Printed Electronics | 17. Others |
| 9. 3D and TSV | |

Abstract Deadline and Paper Submission:

A 300 words abstract to be submitted to the web site below by November 29, 2011.

<http://www.jiep.or.jp/icep/>

It is recommended to attach one piece of figure, picture or table.

Notification of acceptance by the beginning of December, 2011.

Final manuscript to be submitted by February 13, 2012.

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